IFW AF

566.43481CC4 Expedited Procedure Group: 2813

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): N. Fukutomi, et al.

Appln. No.

10/042,408

Filed:

January 8, 2002

For:

FABRICATION PROCESS OF SEMICONDUCTOR PACKAGE AND

SEMICONDUCTOR PACKAGE

Group:

2813

Examiner:

N. Berezny

## **AMENDMENT AFTER FINAL REJECTION**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 August 13, 2004

Sir:

In response to the Office Action mailed May 13, 2004, please amend the above-identified application as listed in the following, and as set forth on the following pages:

Amendments to the Claims; and

Remarks are included following the amendments.